

***Dow Corning*[®] EA-2900 Sealant White**

FEATURES & BENEFITS

- Adhesion to typical electronics substrates
- Adhesion to typical substrates used in lighting modules (e.g., glass, polycarbonate, PMMA, silicone)
- UL94-V1
- Sufficient adhesion strength after 10 minutes already to continue assembly
- Compatible with components used in LED lamps and luminaires devices.

COMPOSITION

- One-part, neutral alkoxy-cure silicone adhesive

Dow Corning[®] EA-2900 Sealant White is a high-performance FAST-ASSEMBLY, 1-part RTV silicone adhesive.

APPLICATIONS

- Bonding and sealing of electronics components and devices.
- Assembling optical parts into LED lamps & luminaires

TYPICAL PROPERTIES

Specification Writers: These values are not intended for use in preparing specifications. Please contact your local Dow Corning sales office or your Global Dow Corning Connection before writing specifications on this product.

Property	Unit	Result
One or Two-Part	-	1
Color	-	White
Extrusion Rate	g/min	190
Specific gravity	g/ml	1.52
Tack-free-time (23°C, 50%R.H.)	Minutes	20
Assembly strength (aluminum lap shear) after 10 minutes	kPa	4
Assembly strength (aluminum lap shear) after 60 minutes	kPa	10
Assembly strength (aluminum lap shear) after 1 day	kPa	100
As cured after 7 days (23°C, 50%R.H.)		
Durometer	Shore A	50
Modulus at 100% elongation	MPa	1.2
Tensile strength at break	MPa	2.1
Elongation at break	%	400
Unprimed Adhesion to Aluminum (lap shear)	MPa	1.5
Unprimed Adhesion to Glass (lap shear)	MPa	1.6
Unprimed Adhesion to Polycarbonate (lap shear)	MPa	1.5
Unprimed Adhesion to PMMA (lap shear)	MPa	1.5
Unprimed Adhesion to Molded Silicone <i>Dow Corning</i> [®] MS-1002 Transparent (lap shear)	MPa	1.0
Unprimed Adhesion to Molded Silicone <i>Dow Corning</i> [®] MS-2002 White (lap shear)	MPa	1.0
UL Flammability classification	94-V1	6mm
Dielectric Strength	volts/mil	434
	kV/mm	17.1
Volume Resistivity	ohm*cm	1.02x10 ¹⁴
Shelf Life at 25°C	Months	12

DESCRIPTION

Dow Corning[®] RTV one-part moisture cure adhesives are generally cured at room temperature and in an environment of 30 to 80 percent relative humidity eliminating the need for curing ovens and the associated costs of energy and capital. Greater than 90 percent of full physical properties should be attained within 24 to 72 hours and varies according to product. Faster manufacturing throughput can be achieved since the adhesive and component can be handled in much shorter times of about 10 to 120 minutes, depending on the adhesive selected and the amount applied. These adhesives are not typically used in highly confined spaces or where a deep section cure is required as they generally cure from the exposed surface inward at a rate of 0.25 inch per seven days. Cure progresses from the outer exposed surface and is dependent on the moisture in the air. Working time is generally a few minutes to an hour for these products until a surface skin begins to form. Mild heat below 60°C (140°F) may be used to increase through-put by accelerating the cure. *Dow Corning* adhesives retain their original physical and electrical properties over a broad range of operating conditions which enhance the reliability of and service life of electronic devices.

PACKAGING INFORMATION

Multiple packaging sizes are available for this product. Please contact your local distributor or Dow Corning representative for information on packaging size and availability.

USABLE LIFE AND STORAGE

For best results, *Dow Corning* adhesives should be stored at or below the storage temperature listed on the product label. Special precautions must be taken to prevent moisture from contacting these materials. Containers should be kept tightly closed with head or air space minimized. Partially filled containers

should be purged with dry air or other gases, such as nitrogen. The product should be stored in its original packaging with the cover tightly attached to avoid any contamination. Store in accordance with any special instructions listed on the product label. The product should be used by its Use Before date as indicated on the product label.

PREPARING SURFACES

All surfaces should be thoroughly cleaned and/or degreased with *Dow Corning*[®] brand OS Fluids, naphtha, mineral spirits, methyl ethyl ketone (MEK) or other suitable solvent. Solvents such as acetone or isopropyl alcohol (IPA) do not tend to remove oils well, and any oils remaining on the surface may interfere with adhesion. Light surface abrasion is recommended whenever possible, because it promotes good cleaning and increases the surface area for bonding. A final surface wipe with acetone or IPA is also useful. Some cleaning techniques may provide better results than others; users should determine the best techniques for their particular applications.

SUBSTRATE TESTING

Due to the wide variety of substrate types and differences in substrate surface conditions, general statements on adhesion and bond strength are impossible. To ensure maximum bond strength on a particular substrate, cohesive failure of the product in a lap shear or similar test is needed to ensure compatibility of the adhesive with the substrate being considered. Also, this test can be used to determine minimum cure time or to detect the presence of surface contaminants such as mold release agents, oils, greases and oxide films.

ADHESION

Dow Corning adhesives are specially formulated to provide unprimed adhesion to many reactive metals, ceramics and glass, as well as to selected laminates, resins and plastics. However, good adhesion cannot be expected on non-reactive metal

substrates or non-reactive plastic surfaces such as Teflon[®], polyethylene or polypropylene. Special surface treatments such as chemical etching or plasma treatment can sometimes provide a reactive surface and promote adhesion to these types of substrates. *Dow Corning*[®] brand primers can be used to increase the chemical activity on difficult substrates. Poor adhesion may be experienced on plastic or rubber substrates that are highly plasticized, because the mobile plasticizers act as release agents. Small-scale laboratory evaluation of all substrates is recommended before production trials are made.

USEFUL TEMPERATURE RANGES

For most uses, silicone adhesives should be operational over a temperature range of -45 to 200°C (-49 to 392°F) for long periods of time. However, at both the low- and high temperature ends of the spectrum, behavior of the materials and performance in particular applications can become more complex and require additional considerations. For low-temperature performance, thermal cycling to conditions such as -55°C (-67°F) may be possible, but performance should be verified for your parts or assemblies. Factors that may influence performance are configuration and stress sensitivity of components, cooling rates and hold times, and prior temperature history. At the high-temperature end, the durability of the cured silicone elastomer is time and temperature dependent. As expected, the higher the temperature, the shorter the time the material will remain useable.

SOLVENT EXPOSURE

The silicone adhesive discussed in this literature is intended only to survive splash or intermittent exposures. It is not suited for continuous solvent or fuel exposure. Testing should be done to confirm performance of the adhesives under these conditions.

**HANDLING
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SAFE USE IS NOT INCLUDED IN
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LIMITATIONS

This product is neither tested nor represented as suitable for medical or pharmaceutical uses.

HEALTH AND ENVIRONMENTAL INFORMATION

To support Customers in their product safety needs, Dow Corning has an extensive Product Stewardship organization and a team of Product Safety and Regulatory Compliance (PS&RC) specialists available in each area.

For further information, please see our website, dowcorning.com or consult your local Dow Corning representative.

LIMITED WARRANTY INFORMATION – PLEASE READ CAREFULLY

The information contained herein is offered in good faith and is believed to be accurate. However, because conditions and methods of use of our products are beyond our control, this information should not be used in substitution for customer's tests to ensure that our products are safe, effective, and fully satisfactory for the intended end use. Suggestions of use

shall not be taken as inducements to infringe any patent.

Dow Corning's sole warranty is that our products will meet the sales specifications in effect at the time of shipment.

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HOW CAN WE HELP YOU TODAY?

Tell us about your performance, design and manufacturing challenges. Let us put our silicon-based materials expertise, application knowledge and processing experience to work for you.

For more information about our materials and capabilities, visit **dowcorning.com**.

To discuss how we could work together to meet your specific needs, email **electronics@dowcorning.com** or go to **dowcorning.com/contactus** for a contact close to your location. Dow Corning has customer service teams, science and technology centers, application support teams, sales offices and manufacturing sites around the globe.

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